

## Novel High-k Application Workshop

June 11<sup>th</sup>, 2019

| Time   | Presenter                  | Institute                       | Title of Presentation   |
|--|----------------------------|---------------------------------|---|
| 9:00   | T. Mikolajick/U. Schroeder | Namlab                          | Welcome   |
| <b>GaN Devices</b> <i>chair: U. Schroeder</i>    |                            |                                 |   |
| 1 9:15   | I. Mitrovic                | University of Liverpool, UK     | Band line-up of high-k oxides on GaN  |
| 2 9:35   | A. Kurek                   | Oxford Instruments, UK          | Atomic Scale Processing for GaN Devices   |
| 3 9:55   | N. Bickel                  | FBH, Berlin, D                  | Thermal and Plasma ALD Al <sub>2</sub> O <sub>3</sub> Gate Insulator for GaN Electronic Devices Characterized by CV-Stress Measurements |
| 4 10:15  | S. Seidel                  | TUBA Freiberg, D                | GdScO <sub>3</sub> as epitaxial grown dielectric for MISHEMTs   |
| 5 10:35  | A. Calzolaro               | Namlab Dresden, D               | ALD Al <sub>2</sub> O <sub>3</sub> dielectrics for AlGaN/GaN MIS HEMT gate modules  |
| Coffee break: 10:55 - 11:30h                     |                            |                                 |   |
| <b>Novel Devices</b> <i>chair: T. Mikolajick</i> |                            |                                 |   |
| 6 11:30  | M. Knaut                   | TU Dresden, IHM, D              | TSVFET - Functionalization of Through Silicon VIAs by the Integration of a Field-Effect Transistor                                      |
| 7 11:50  | M. Lammel                  | IFW, Dresden, D                 | Ferromagnetic insulators for future spintronic devices  |
| 8 12:10  | T. Mauersberger            | Namlab Dresden, D               | The role of dielectric mismatch in nanowire based devices   |
| 9 12:30  | M. Czernohorsky            | Fraunhofer IPMS-CNT, Dresden, D | High-density energy storage in Si-doped hafnium oxide thin films on area-enhanced substrates  |
| 10 12:50   | H. Winterfeld              | Univ. Kiel, D                   | MISFET based piezo-stress sensor with AlN gate dielectric   |
| Lunch - MPI PKS: 13:10 - 14:15h                  |                            |                                 |   |
| <b>RRAM</b> <i>chair: S. Slesazeck</i>           |                            |                                 |   |
| 11 14:15   | M. Ziegler                 | TU Ilmenau, D                   | Memristive Devices for On-Chip Learning in Neural Networks  |
| 12 14:35   | L. Alff                    | Univ. Darmstadt, D              | Oxygen engineered HfO <sub>x</sub> -based memristive devices  |
| 13 14:55   | C. Wenger                  | IHP Frankfurt/Oder, D           | Towards neuromorphic computing: Inherent stochastic learning in memristive HfO <sub>2</sub> arrays                                      |
| 14 15:15   | U. Böttger                 | RWTH Aachen, D                  | Resistive Switching in VCM cells  |
| 15 15:35   | M. Herzig                  | Namlab Dresden, D               | Sub-microscaled NbO <sub>x</sub> -based threshold switches as selector devices  |
| Coffee break: 15:55 - 16:30h                     |                            |                                 |   |
| <b>Solar</b> <i>chair: M. Grube</i>              |                            |                                 |   |
| 16 16:30   | M. Godlewski               | Acad. of Sc. Warsaw, PL         | ALD for new generations of solar cells  |
| 17 16:50   | D. Spoltore                | IAPP, Dresden, D                | Intermolecular Charge-Transfer states for Organic Opto-electronics  |
| 18 17:10   | C. Strobel                 | TU Dresden, IHM, D              | Comparison of amorphous silicon deposition methods for a-Si / c-Si heterojunction solar cells   |
| 19 17:30   | D. Troeger                 | Namlab Dresden, D               | Towards Full Area Passivating Contacts for enhanced PERC Solar Cell Concepts  |
| 17:50  | End                        |                                 |   |
| 19:30  | Workshop Dinner            | Pullman Hotel                   | sponsored by Oxford Instruments   |

## Novel High-k Application Workshop

June 12<sup>th</sup>, 2019

|   |                  |                                |  |
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| <b>FeCap</b> <i>chair: U. Schroeder</i>       |                  |                                |  |
| 1 9:00  | P. Nukala        | Univ. of Groningen/Netherlands | Ferroelectricity through nanoscopic confinement effects in epitaxially grown HfO <sub>2</sub> -ZrO <sub>2</sub> thin-films                             |
| 2 9:20  | L. Grenouillet   | LETI/France                    | Investigation of HfO <sub>2</sub> :Si ferroelectric properties by 2 different techniques : ALD vs Si ion implantation                                  |
| 3 9:40  | B. Vilquin       | Univ. Lyon/France              | Huge working pressure effect on the ferroelectric properties of RF sputtered hafnia/zirconia layers  |
| 4 10:00                                       | F. Berg          | RWTH Aachen/Germany            | Influence of process parameters on the ferroelectric properties of sputtered hafnium oxide   |
| 5 10:20                                       | A. Dimoulas      | Demokritos Athens/Greece       | High remanent polarization ferroelectric Hf <sub>1-x</sub> Zr <sub>x</sub> O <sub>2</sub> on Ge substrates by plasma enhanced atomic oxygen deposition |
| Coffee break: 10:40 - 11:10h                  |                  |                                |  |
| <b>FeFET/NCFET</b> <i>chair: S. Slesazeck</i> |                  |                                |  |
| 7 11:10                                       | M. Mennenga      | FMC/Dresden                    | Recent characterization results for HfO <sub>2</sub> based FeFETs on 28 nm HKMG technology   |
| 8 11:30                                       | H. Mulaosmanovic | Namlab Dresden/Germany         | Switching kinetics in ferroelectric HfO <sub>2</sub> for memory applications and unconventional computing  |
| 9 11:50                                       | M. Lederer       | IPMS-CNT, Dresden/Germany      | FeFET Reliability  |
| 10 12:10                                      | H.W. Park        | Seoul National Univ./Korea     | Negative capacitance in ferroelectric thin film from phase field model approach  |
| 11 12:30                                      | M. Hoffmann      | Namlab Dresden/Germany         | Negative capacitance effects in ferroelectric HfO <sub>2</sub>   |
| Lunch break: 12:50 - 14:00h                   |                  |                                |  |
| <b>FTJ/FeCap</b>                              |                  |                                |  |
| 13 14:00                                      | Y. Wei           | Univ. of Groningen/Netherlands | Multiferroic tunnel junctions based on ferroelectric Hf <sub>0.5</sub> Zr <sub>0.5</sub> O <sub>2</sub> barriers                                       |
| 12 14:20                                      | N. Ronchi        | IMEC, Leuven/Belgium           | Recent development on 3D FeFET   |
| 13 14:40                                      | A. Toriumi       | University of Tokyo/Japan      | Impact of quenching in post deposition anneals on ferroelectric HfO <sub>2</sub>   |
| 14 15:00                                      | F. Mehmood       | Namlab Dresden/Germany         | Reliability Characterization of Lanthanum Doped Hafnium Zirconium Oxide based Ferroelectric Capacitors   |
| 15 15:20                                      | M. Falkowski     | UAS Munich/ Germany            | Nucleation model for ferroelectric HZO using first principles data   |
| Coffee break: 15:40 - 16:00h                  |                  |                                |  |
| <b>Characterization</b>                       |                  |                                |  |
| 16 16:00                                      | J. I. Flege      | BTU Cottbus, Germany           | In situ real-time studies of rare-earth oxide growth, structure, and chemistry with low-energy electron microscopy                                     |
| 17 16:20                                      | A. Gruverman     | Lincoln, Nebraska/USA          | Domain kinetics and imprint phenomena in HfO <sub>2</sub> -based capacitors  |
| 18 16:40                                      | I. Stolichnov    | EPF Lausanne/Switzerland       | Genuinely Ferroelectric Sub-1-Volt-Switchable Nanodomains in Hf <sub>x</sub> Zr <sub>(1-x)</sub> O <sub>2</sub> Ultrathin Capacitors                   |
| 19 17:00                                      | A. Zenkevich     | MIPT, Moscow/Russia            | Measurements of electric potential distribution across nanoscale ferroelectric HfO <sub>2</sub> capacitors by HAXPES                                   |
| 20 17:20                                      | N. Barrett       | CEA-Saclay, Paris/France       | Non-destructive XPS study of the TiN/Hf <sub>0.5</sub> Zr <sub>0.5</sub> O <sub>2</sub> interface  |
| 21 17:40                                      | M. Mueller       | FZ Juelich/Germany             | Impact of oxygen content on ferroelectric properties   |
| 18:00   | End              |                                |  |

### Poster session: June 12th during coffee breaks

|   |             |                          |  |
|---|-------------|--------------------------|--|
| 1 | L. Pintilie | NIMP/ Romania            | Structural and electrical characterization of HZO-based structures   |
| 2 | C. Gastaldi | EPF Lausanne/Switzerland | Negative capacitance in HZO-based heterostructures: insight from pulse switching and PFM nanoscale imaging |
| 3 | T. Szyjka   | FZ Juelich/Germany       | HAXPES Study of Oxygen Vacancies in HfO <sub>2</sub> -based Ferroelectric Capacitors                       |